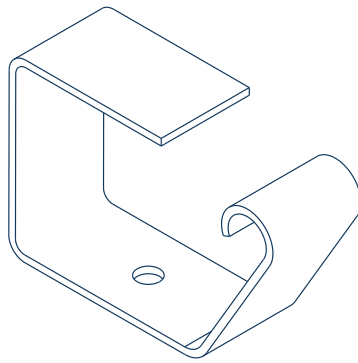




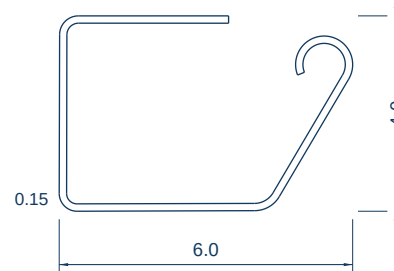
Type C-08 BC08-20060040

SMD EMI Spring Contact | Beryllium Copper | Units: mm

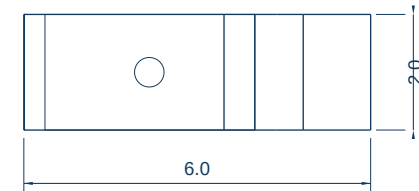
Isometric



Front view (mm)



Top view (mm)



MECHANICAL

VALUE

Thickness	0.15 mm
Width	2.0 mm +/- 0.2
Length	6.0 mm +/- 0.2
Height	4.0 mm +/- 0.2
Form	box section: top arm, wall, base, ramp, hook
Corner bends	R0.302 / R0.280 CL, 90 deg
Base-to-ramp	R0.499 CL, 59 deg
Hook	R0.493 CL, 232 deg
Base hole	dia 0.51 mm at 2.17 from end
Material / plating	BeCu, Gold-plated (G)
Volume / mass	4.841 mm ³ 40.5 mg (BeCu)
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	BC08-20060040G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 6.0x2.0x4.0mm
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-c-08.html